



D3V3F4U10LPQ

### 4 CHANNEL LOW CAPACITANCE TVS DIODE ARRAY

### **Product Summary**

-		
VBR (MIN)	IPP (MAX)	CI/O (TYP)
5.5V	5	0.5pF

### Description

The D3V3F4U10LPQ is a high-performance device suitable for protecting four high speed I/Os. These devices are assembled in U-DFN2510-10 package and have high ESD surge capability, low ESD clamping voltage and ultra-low capacitance.

# **Applications**

Typically used at high-speed ports such as USB 3.0, USB 3.1, serial ATA, display ports.

### Features

- Clamping Voltage: 5V at 16A IEC61000-4-2
- IEC61000-4-2 (ESD): Air ±12kV, Contact ±12kV
- IEC61000-4-5 (Lightning): 5A (8/20µs)
- 4 Channels of ESD Protection
- Ultra-Low Chanel Input Capacitance of 0.5pF Typical
- TLP Dynamic Resistance: 0.25Ω
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The D3V3F4U10LPQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

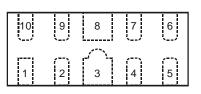
https://www.diodes.com/guality/product-definitions/

### Mechanical Data

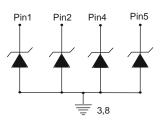
- Package: U-DFN2510-10
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 @
- Weight: 0.004 grams (Approximate)

#### U-DFN2510-10

Pin #	Description
1, 2, 4, 5	I/O
6, 7, 9, 10	No Connection
3, 8	Vss



Pin Description (Top View)



**Device Schematic** 

## Ordering Information (Note 4)

Part Number	Paakaga	Marking	Reel Size (inches)	Tape Width (mm)	Pa	cking
Part Nulliber	nber Package Marking Reel Size (inches)	rape width (mm)	Qty.	Carrier		
D3V3F4U10LPQ-7	U-DFN2510-10	QD6	7	8	3,000	Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

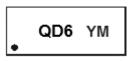
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



# **Marking Information**

Option A:

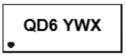


QD6 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: K = 2023) M = Month (ex: 9 = September) Dot Denotes Cathode Side

#### Date Code Key:

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	I	J	К	L	М	Ν	Р	R	S	Т	U	V
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code		0	0	4	~	<u> </u>	7	0	0	0	N	

Option B:



QD6 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 3 = 2023) W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday) Dot Denotes Cathode Side

#### Date Code Key

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	1	2	3	4	5	6	7	8	9	0	1	2
Week		1-26				27-52			53			
Code		A	-Z		a-z			z				
Internal Code	Sı	ın	Mor	1	Tue	1	Wed	Thu		Fri		Sat
Code	٦		U		V		W	Х		Y		Z

### Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Condition
Peak Pulse Current, per IEC61000-4-5	IPP	5	А	I/O to Vss, 8/20µs
Peak Pulse Power, per IEC61000-4-5	Ppp	30	W	I/O to Vss, 8/20µs
ESD Protection – Contact Discharge, per IEC61000-4-2	Vesd_contact	±12	kV	I/O to Vss
ESD Protection – Air Discharge, per IEC61000-4-2	Vesd_air	±12	kV	I/O to Vss

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation Typical (Note 5)	PD	350	mW
Thermal Resistance, Junction to Ambient Typical (Note 5)	R <sub>θJA</sub>	360	°C/W
Operating and Storage Temperature Range	TJ,TSTG	-55 to +150	°C

Note: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

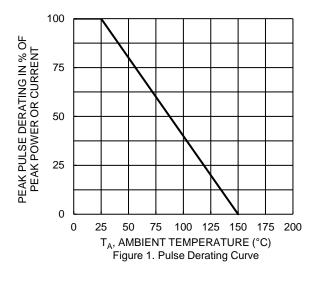


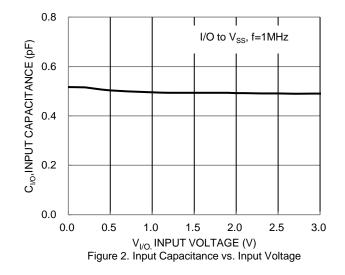
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

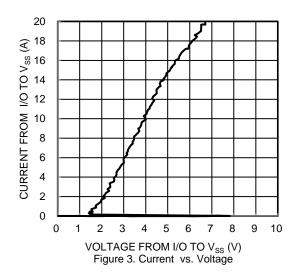
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Working Voltage	Vrwm		—	3.3	V	—
Reverse Current	IR	_	_	1.0	μA	$V_R = 3.3V$ , I/O to Vss
Reverse Breakdown Voltage	V <sub>BR</sub>	5.5	6.2	_	V	$I_R = 1$ mA, I/O to V <sub>SS</sub>
Forward Clamping Voltage	VF	-1.0	-0.85	_	V	IF = -15mA, I/O to Vss
Holding Reverse Voltage	VHOLD	_	1.3	_	V	I/O to Vss
Reverse Clamping Voltage (Note 6)	Vc	_	3.5	_	V	I <sub>PP</sub> = 5A, I/O to V <sub>SS</sub> , 8/20µs
Clamping Voltage (Note 7)	Vc	_	5	—	V	TLP, 16A, $t_P = 100$ ns, I/O to V <sub>SS</sub>
Clamping Voltage (Note 7)	Vc		5	—	V	TLP, -16A, $t_P$ = 100ns, I/O to V <sub>SS</sub>
Dynamic Reverse Resistance	Rdif-r		0.25	_	Ω	TLP, 10A, t <sub>P</sub> = 100ns, I/O to Vss
Dynamic Forward Resistance	R <sub>DIF-F</sub>	—	0.2	—	Ω	TLP, 10A, t <sub>P</sub> = 100ns, V <sub>SS</sub> to I/O
Channel Input Capacitance	Ci/O	—	0.5	—	pF	VI/O = 0V, Vss = 0V, f = 1MHz

Notes: 6. Clamping voltage value is based on an 8x20µs peak pulse current (IPP) waveform.

7. Clamping voltage value is based on a TLP model. TLP conditions: Z<sub>0</sub>=50Ω, t<sub>P</sub> = 100ns, t<sub>P</sub> = 1ns, averaging window; t1=70ns to t2=90ns.





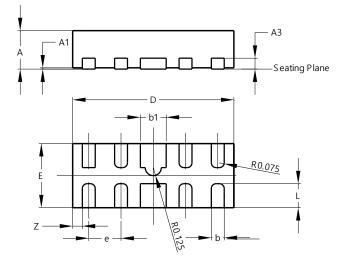




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

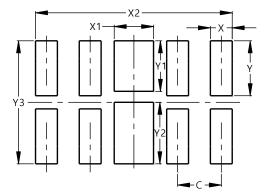
#### U-DFN2510-10



	U-DFN2510-10						
Dim	Min	Max	Тур				
Α	0.545	0.605	0.575				
A1	0.00	0.05	0.03				
A3	-	-	0.13				
b	0.15	0.25	0.20				
b1	035	0.45	0.40				
D	2.450	2.575	2.500				
е	-	-	0.50				
Е	0.950	1.075	1.000				
L	0.325	0.425	0.375				
Z	-	-	0.150				
AI	l Dimens	sions in	mm				

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



### U-DFN2510-10

Dimensions	Value (in mm)
С	0.500
Х	0.250
X1	0.450
X2	2.250
Y	0.625
Y1	0.575
Y2	0.700
Y3	1.400



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